

### 40V Dual N-Channel Enhancement Mode MOSFET

Voltage

40 V

Current

53 A

#### **Features**

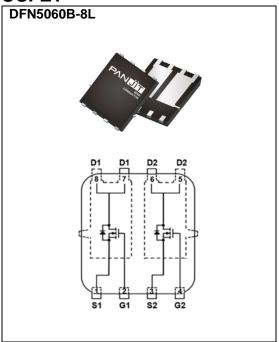
- RDS(ON), VGS@10V, ID@10A<8m $\Omega$
- RDS(ON), VGS@4.5V, ID@6A<12m $\Omega$
- Excellent FOM
- Logic Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

• Case: DFN5060B-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.092 grams



### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		$V_{GS}$	±20	V	
Continuous Drain Current (Note 3)	T <sub>C</sub> =25°C		53		
	T <sub>C</sub> =100°C	l <sub>D</sub>	38	Α	
Pulsed Drain Current (Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	212		
Power Dissipation	T <sub>C</sub> =25°C	-	42	W	
	T <sub>C</sub> =100°C	PD	21		
Continuous Drain Current (Note 4)	T <sub>A</sub> =25°C	Ι <sub>D</sub>	13.2	А	
	T <sub>A</sub> =70°C		11		
Power Dissipation	T <sub>A</sub> =25°C	PD	2.5	W	
	T <sub>A</sub> =70°C		1.8		
Single Pulse Avalanche Current (Note 5)		I <sub>AS</sub>	7.7	Α	
Single Pulse Avalanche Energy (Note 5)		E <sub>AS</sub>	28	mJ	
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~175	°C	
Thermal Resistance (Note 4)	Junction to Case	Rejc	3.6	°C/W	
	Junction to Ambient	$R_{\theta JA}$	60		



### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

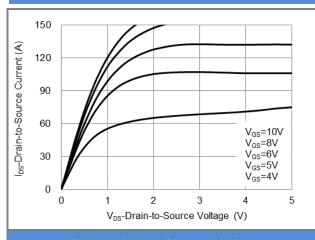
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	S V <sub>GS</sub> =0V, I <sub>D</sub> =250uA 40		-	-	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.1	1.5	2.3	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	-	6.3	8	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A	-	8.9	12	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
Dynamic <sup>(Note 6)</sup>						
Total Gate Charge	$Q_g$	V <sub>DS</sub> =32V, I <sub>D</sub> =10A,	ı	17.4	25	nC
Gate-Source Charge	Qgs		ı	1.8	-	
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	5.2	-	
Input Capacitance	Ciss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,	-	706	1000	pF
Output Capacitance	Coss		-	227	340	
Reverse Transfer Capacitance	Crss	f=1MHz	-	24	42	
Gate resistance	Rg	f=1MHz	-	1.2	-	Ω
Turn-On Delay Time	td <sub>(on)</sub>	V <sub>DS</sub> =32V, I <sub>D</sub> =10A, V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω	-	6	-	ns
Turn-On Rise Time	tr		-	3.6	-	
Turn-Off Delay Time	td <sub>(off)</sub>		-	20	-	
Turn-Off Fall Time	tf	(Note 2)	-	6.4	-	
Drain-Source Diode	•			•	•	
Diode Forward Current	Is	T <sub>C</sub> =25°C	-	-	44	А
Pulsed Diode Forward Current	I <sub>SM</sub>	(Package Limit)	-	-	212	
Diode Forward Voltage	$V_{SD}$	Is=20A, V <sub>GS</sub> =0V	-	0.8	1.3	V
Reverse Recovery Time	Trr	V <sub>DD</sub> =32V, V <sub>GS</sub> =0V,	-	15	-	ns
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	10	-	nC

#### NOTES:

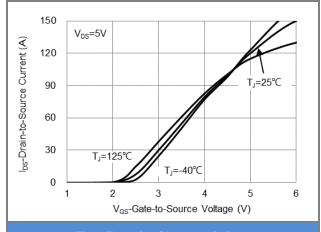
- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an  $R_{\theta JC}=3.6^{\circ}C/W$ .
- 4. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. E<sub>AS</sub> is calculated based on the condition of L=1mH, I<sub>AS</sub>=7.5A, V<sub>DD</sub>=30V, V<sub>GS</sub>=10V. 100% test at L=0.5mH, I<sub>AS</sub>=7.7A in production.
- 6. Guaranteed by design, not subject to production testing.



#### **TYPICAL CHARACTERISTIC CURVES**



**Fig.1 On-Region Characteristics** 



**Fig.2 Transfer Characteristics** 

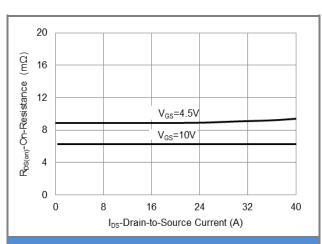


Fig.3 On-Resistance vs. Drain Current

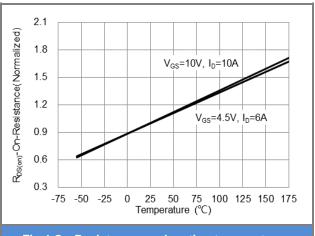
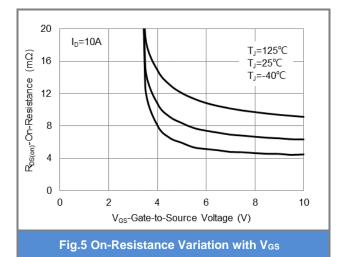


Fig.4 On-Resistance vs. Junction temperature



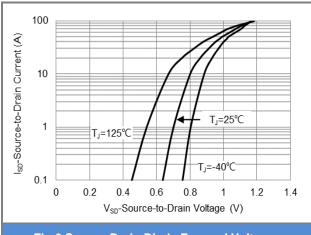


Fig.6 Source-Drain Diode Forward Voltage



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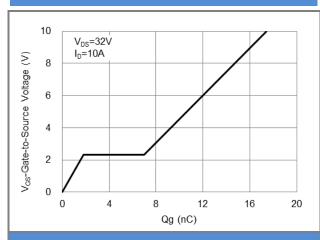


Fig.7 Gate-Charge Characteristics

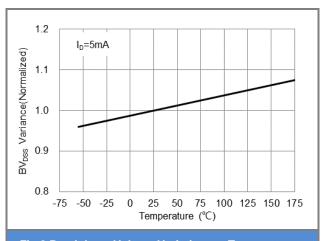


Fig.8 Breakdown Voltage Variation vs. Temperature

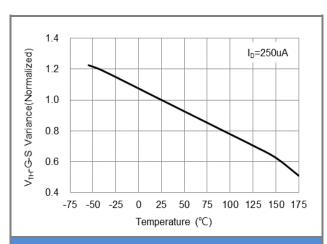


Fig.9 Threshold Voltage Variation with Temperature

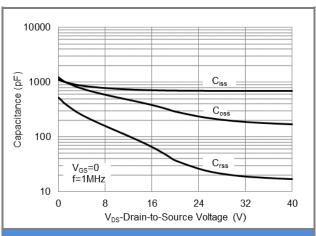
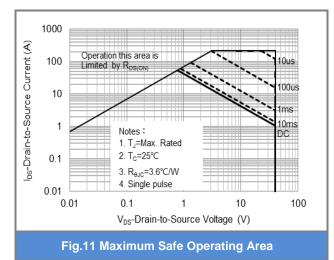


Fig.10 Capacitance vs. Drain-Source Voltage



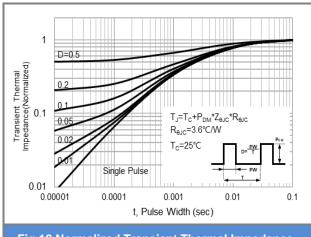


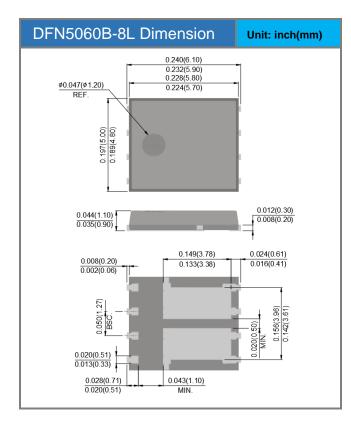
Fig.12 Normalized Transient Thermal Impedance

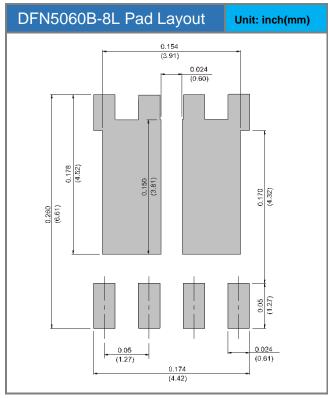


### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking
PJQ5948S6-AU	DFN5060B-8L	3K pcs / 13" reel	Q5948S6

# **Packaging Information & Mounting Pad Layout**







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